

**PATENT ASSIGNMENT**

Electronic Version v1.1  
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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT								
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT								
<b>CONVEYING PARTY DATA</b>									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>James A. Sack</td> <td>05/08/2008</td> </tr> <tr> <td>Dr. Mohit K. Bhatnagar</td> <td>05/08/2008</td> </tr> <tr> <td>Jack Y. Yeh</td> <td>05/08/2008</td> </tr> </tbody> </table>		Name	Execution Date	James A. Sack	05/08/2008	Dr. Mohit K. Bhatnagar	05/08/2008	Jack Y. Yeh	05/08/2008
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James A. Sack	05/08/2008								
Dr. Mohit K. Bhatnagar	05/08/2008								
Jack Y. Yeh	05/08/2008								
<b>RECEIVING PARTY DATA</b>									
<b>Name:</b>	JMEA Corporation								
<b>Street Address:</b>	1 Research Court, Suite 450								
<b>City:</b>	Rockville								
<b>State/Country:</b>	MARYLAND								
<b>Postal Code:</b>	20850								
<b>PROPERTY NUMBERS Total: 1</b>									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12118503</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12118503				
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Application Number:	12118503								
<b>CORRESPONDENCE DATA</b>									
<b>Fax Number:</b>	(301)365-9101								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
<b>Phone:</b>	301.865.3132								
<b>Email:</b>	michael.lee@plumsea.com								
<b>Correspondent Name:</b>	Plumsea Law Group, LLC								
<b>Address Line 1:</b>	10411 Motor City Drive, Suite 320								
<b>Address Line 4:</b>	Bethesda, MARYLAND 20817								
<b>ATTORNEY DOCKET NUMBER:</b>	39-1029								
<b>NAME OF SUBMITTER:</b>	Michael S. Lee								
<b>Total Attachments: 2</b> source=39-1029_2008-05-15_Executed_Assignment#page1.tif source=39-1029_2008-05-15_Executed_Assignment#page2.tif									

OP \$40.00 12118503

**PATENT**

**500540537**

**REEL: 020950 FRAME: 0634**

**ASSIGNMENT**

WHEREAS, James A. Sack, a citizen of the United States of America, residing at Elverson, Pennsylvania, U.S.A.; Dr. Mohit K. Bhatnagar, a citizen of the United States of America, residing at Potomac, Maryland, U.S.A.; and Jack Y. Yeh, a citizen of the United States of America, residing at North Potomac, Maryland, U.S.A.; hereinafter (collectively) referred to as the Assignor, have invented certain new and useful improvements in

**DISK FUSION IMPLANT**

for which an application for Letters Patent of the United States has been prepared,

- the Declaration for said application executed on even date herewith;
- said application having been filed in the United States Patent and Trademark Office on \_\_\_\_\_ and accorded Serial Number \_\_\_\_\_, and was amended on \_\_\_\_\_ (if applicable);
- said application having been filed under the Patent Cooperation Treaty on \_\_\_\_\_ and accorded Application No. \_\_\_\_\_, the United States of America being designated;

WHEREAS, JMEA Corporation  
1 Research Court  
Suite 450  
Rockville, MD 20850  
U.S.A.

is desirous of acquiring the entire right, title and interest in and to the aforesaid invention and in and to any Letters Patent of the United States or any foreign country which may be granted therefor;

NOW THEREFORE, for good and valuable consideration the Assignor by these presents do sell, assign, and transfer unto the Assignee, its successors, legal representatives and assigns, the full and exclusive right to the invention as described in said application, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations and extensions thereof;

AND said Assignor authorizes and requests the Commissioner of Patents and Trademarks or any other proper officer or agency of any country to issue all said Letters Patent to said Assignee;

AND said Assignor warrants and covenants that I/We have full right to convey the entire interest herein assigned and that I/We have not executed and will not execute any instrument or assignment in conflict herewith;

AND said Assignor agrees to communicate to said Assignee or its representatives any facts known to me/us respecting said invention, to execute all divisional, continuation, reissue and foreign applications, sign all lawful documents and make all rightful oaths relating to said invention, and to testify in any judicial or administrative proceeding and generally do everything possible to aid the said Assignee to obtain and enforce said Letters Patent in the United States or any foreign country when requested so to do by said Assignee.

IN WITNESS WHEREOF, I/We have hereunto set my/our hand and seal.

Date: 5/8/08

Signature: James A. Sack  
Name: James A. Sack

Date: \_\_\_\_\_

Signature: \_\_\_\_\_  
Name: Dr. Mohit K. Bhatnagar

Date: \_\_\_\_\_

Signature: \_\_\_\_\_  
Name: Jack Y. Yeh

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Name: Dr. Mohit K. Bhatnagar

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Signature: Jack Y. Yeh  
Name: Jack Y. Yeh